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For use in high safety and reliability-required devices/circuits of general electronic equipment, thorough safety evaluation prior to use is strongly recommended, and a protective circuit should be designed and installed as necessary.

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## **MULTILAYER CERAMIC CAPACITORS**



REFLOW

### ■PARTS NUMBER

J M K 3	1 6 🛆	ВЈ	1 0 6	M L H	Т 🛆	△=Blank spac
<u>(1)</u> <u>(2)</u> <u>(3)</u>	<b>4</b> ) <b>5</b>	6	(7)	8 9 10	1) (1) (12)	

①Rated voltage

Code	Rated voltage[VDC]
Α	4
J	6.3
L	10
E	16
Т	25
G	35
U	50
Н	100
Q	250
S	630

#### 2 Series name

Code	Series name
M	Multilayer ceramic capacitor
W	LW reverse type multilayer capacitor

3End termination

Code	End termination
K	Plated
R	High Reliability Application

4Dimension (L × W)

Туре	Dimensions (L×W)[mm]	EIA (inch)
105	1.0 × 0.5	0402
105	0.52 × 1.0 💥	0204
107	1.6 × 0.8	0603
107	0.8 × 1.6 💥	0306
010	2.0 × 1.25	0805
212	1.25 × 2.0 ※	0508
316	3.2 × 1.6	1206
325	3.2 × 2.5	1210
432	4.5 × 3.2	1812

Note: ※LW reverse type(□WK) only

5Dimension tolerance

Code	Туре	L[mm]	W[mm]	T[mm]
Δ	ALL	Standard	Standard	Standard
	105	1.0±0.10	0.5±0.10	0.5±0.10
	107	1.6+0.15/-0.05	0.8+0.15/-0.05	0.8+0.15/-0.05
Α	212	2.0+0.15/-0.05	1.25+0.15/-0.05	0.85±0.10
^	212	2.0+0.19/ -0.05	1.25+0.15/-0.05	1.25+0.15/-0.05
	316	3.2±0.20	1.6±0.20	1.6±0.20
	325	3.2±0.30	2.5±0.30	2.5±0.30
	105	1.0+0.15/-0.05	0.5+0.15/-0.05	0.5+0.15/-0.05
	107	1.6+0.20/-0	0.8+0.20/-0	0.8+0.20/-0
В	212	2.0+0.20/-0	1.25+0.20/-0	0.85±0.10
	212	2.0 + 0.20/ - 0	1.25 + 0.20/ -0	1.25+0.20/-0
	316	3.2±0.30	1.6±0.30	1.6±0.30
С	105	1.0+0.20/-0	0.5+0.20/-0	0.5+0.20/-0

Note: P.17 Standard external dimensions

Δ= Blank space

### **6**Temperature characteristics code

### ■ High dielectric type

■ Filigit dielectric type								
Code	Applicable standard		Temperature range [°C]	Ref. Temp.[°C]	Capacitance change	Capacitance tolerance	Tolerance code	
BJ	EIA	X5R	-55 <b>~</b> + 85	25	±15%	±10%	К	
БО	EIA	YOK	-55° + 65	25	± 13%	±20%	М	
В7	EIA X7R	EIA V7D	V7D	-55 <b>~</b> +125	25	±15%	±10%	К
ь/		Λ/Κ	-557 <del>-</del> 7125	25	上1970	±20%	М	
C6	EIA	X6S	-55~+105	25	±22%	±10%	К	
	EIA	703	-55° + 105	25		±20%	М	
C7 EIA X7S -55~+125 25	25	+220/	±10%	К				
	EIA X/S	IA   X/S   -55~ + 125   25	±22%	±20%	М			

■Temperature compensating type

Code		cable dard	Temperature range[°C]	Ref. Temp.[°C]	Capacitance change	Capacitance tolerance	Tolerance code								
						±0.1pF	В								
	JIS	JIS CG 20		±0.25pF	С										
CG			-55 <b>~</b> +125		0±30ppm/°C	±0.5pF	D								
CG											33.3 T 123		о±зоррпі/ С	±1pF	F
	EIA	C0G	25	±5%	J										
						±10%	K								

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

### 7)Nominal capacitance

Trioninal capacitance					
Code (example)	Nominal capacitance				
0R5	0.5pF				
010	1pF				
100	10pF				
101	100pF				
102	1,000pF				
103	10,000pF				
104	0.1 μ F				
105	1.0 <i>μ</i> F				
106	10 μ F				
107	100 μ F				
Note - D-D-sized a sixt					

### Note : R = Decimal point

### ®Capacitance tolerance

@Capacitance tolerance					
Code	Capacitance tolerance				
В	±0.1pF				
С	±0.25pF				
D	±0.5pF				
J	±5%				
K	±10%				
M	±20%				
①Internal code					
Code	Internal code				

Standard

### Thickness

Code	Thickness[mm]
V	0.5
Α	0.8
D	0.85(212type or more)
F	1.15
G	1.25
Н	1.5
L	1.6
N	1.9
М	2.5

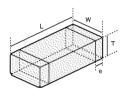
### **®**Special code

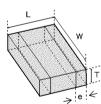
Code	Special code
_	
Н	MLCC for Industrial, Automotive Comfort
	and Safety

#### (1)Packaging

101 donaging	
Code	Packaging
F	$\phi$ 178mm Taping (2mm pitch)
Т	$\phi$ 178mm Taping (4mm pitch)
Р	φ 178mm Taping (4mm pitch, 1000 pcs/reel) 325 type (Thickness code M)

### ■STANDARD EXTERNAL DIMENSIONS





LW reverse type

T ( FIA )		D	imension [mm]		
Type( EIA )	L	W	Т	*1	е
□MK105(0402)	1.0±0.05	0.5±0.05	0.5±0.05	٧	0.25±0.10
□WK105(0204)※	$0.52 \pm 0.05$	1.0±0.05	$0.3 \pm 0.05$	Р	0.18±0.08
□MK107(0603)	1.6±0.10	0.8±0.10	$0.8 \pm 0.10$	Α	$0.35 \pm 0.25$
□MR107(0603)	1.6±0.10	0.8±0.10	0.8±0.10	Α	0.1~0.6
□WK107(0306)※	0.8±0.10	1.6±0.10	$0.5 \pm 0.05$	V	0.25±0.15
□MK212(0805)	2.0±0.10	1.25±0.10	0.85±0.10	D	0.5±0.25
LIMK212(0805)	2.0±0.10	1.25±0.10	1.25±0.10	G	0.5±0.25
□MR212(0805)	2.0±0.10	1.25±0.10	1.25±0.10	G	0.25~0.75
□WK212(0508)※	1.25±0.15	2.0±0.15	$0.85 \pm 0.1$	D	$0.3 \pm 0.2$
□MK316(1206)	3.2±0.15	1.6±0.15	1.15±0.10	F	0.5+0.35/-0.25
□MK310(1200)	3.2±0.15	1.0±0.15	1.6±0.20	L	0.5 + 0.35/ - 0.25
□MR316(1206)	3.2±0.15	1.6±0.15	1.6±0.20	L	0.25~0.85
			1.15±0.10	F	
□MK325(1210)	3.2±0.30	2.5±0.20	1.5±0.10	Н	0.6±0.3
□IMIK323(1210)	3.2 ± 0.30	2.5 ± 0.20	1.9±0.20	N	0.0 ± 0.3
			2.5±0.20	М	
□MR325(1210)	2.2 + 0.20	0.5 ± 0.00	1.9±0.20	N	0.200
□MK323(1210)	3.2±0.30	2.5±0.20	2.5±0.20	М	0.3~0.9
□MK432(1812)	2) 4.5±0.40 3.2±0.30 2.5±		2.5±0.20	М	0.9±0.6
Note: X. LW reverse type, *	1.Thickness cod	e			

#### Note: X. LW reverse type, \*1. Thickness code

### STANDARD QUANTITY

т	FIA (in ala)	Dime	nsion	Standard q	uantity[pcs]
Type	EIA (inch)	[mm]	Code	Paper tape	Embossed tape
105	0402	0.5	V	10000	
105	0204 ※	0.30	Р	10000	_
107	0603	0.8	Α	4000	_
107	0306 ※	0.50	V	_	4000
	0805	0.85	D	4000	_
212	0805	1.25	G	=	3000
	0508 ※	0.85	D	4000	_
316	1206	1.15	F	_	3000
310	1200	1.6	L	_	2000
		1.15	F		
325	1210	1.5	Н	_	2000
323	1210	1.9	N		
		2.5	М	_	500(T), 1000(F
432	1812	2.5	М	_	500

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[Temperature Characteristic	ic BJ : X5R】 1.9mm thick	kness(N)									
Part number 1	D. 1	Rated voltage [V]	Tempe	rature	Capacitance	Capacitance	tan δ	HALT	*3 - 3	Soldering	Ì
Part number 1	Part number 2	Rated Voltage [V]	charact	eristics	[F]	tolerance [%]	[%]	Rated voltage x %	Thickness*3 [mm]	R:Reflow W:Wave	
UMK325 BJ475∏NHT		50		X5R	4.7 μ	±10, ±20	10	150	1.9 ± 0.20	R	
GMK325 BJ225MNHT		35		X5R	2.2 μ	±20	3.5	200	1.9±0.20	R	
GMK325 BJ475∏NHT		30		X5R	4.7 μ	±10, ±20	10	150	1.9 ± 0.20	R	
TMK325 BJ475[NHT		25		X5R	4.7 μ	±10, ±20	10	150	1.9±0.20	R	
EMK325 BJ475MNHT		16		X5R	4.7 μ	±20	3.5	200	1.9±0.20	R	•
FMK325 BJ106∏NHT		10		X5R	10 //	+10 +20	5	150	19+020	R	

Temperature Characterist	ic BJ : X5R】 1.5mm thick	kness(H)								
Part number 1	Part number 2	Rated voltage [V]	Tempe	erature	Capacitance	Capacitance	tan δ	HALT	*3 [ ]	Soldering R:Reflow
rart number i	Fart Humber 2	Nated Voltage [V]	charact	eristics	[F]	tolerance [%]	[%]	Rated voltage x %		W:Wave
UMK325 BJ105MHHT		50		X5R	1 μ	±20	3.5	200	1.5±0.10	R
TMK325 BJ225MHHT		25		X5R	2.2 μ	±20	3.5	200	1.5±0.10	R

[Temperature Characterist	ic C6 : X6S】 2.5mm thick	ness(M)								
Part number 1	Part number 2	Rated voltage [V]	Tempera character		Capacitance [F]	Capacitance tolerance [%]	tan δ [%]	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave
JMK325AC6107MMHT		6.3		X6S	100 μ	±20	10	150	2.5±0.30	R

Temperature Characterist	ic B7 : X7R , C7 : X7S】 2	.5mm thickness (M)							
Part number 1	Part number 2	Rated voltage [V]	Temperature	Capacitance	Capacitance	tan δ	HALT	Thickness*3 [mm]	Soldering R:Reflow
Fart number 1	Fart number 2	Nated Voltage [V]	characteristic	; [F]	tolerance [%]	[%]	Rated voltage x %	Inickness [mm]	W:Wave
UMK325 B7475 MHT		50	X7F	4.7 μ	±10, ±20	5	150	$2.5 \pm 0.20$	R
UMK325AC7106MMHT		30	X75	10 μ	±20	10	150	2.5±0.30	R
GMK325 C7106 MHT		35	X75	10 μ	±10, ±20	5	150	2.5±0.30	R
TMK325AB7106□MHTR		25	X7F	10 μ	±10, ±20	10	150	2.5±0.30	R
EMK325 B7226[]MHT		16	X7F	22 μ	±10, ±20	10	150	2.5±0.20	R
LMK325 C7226MMHT		10	X75	22 μ	±20	5	150	2.5±0.20	R
JMK325 B7226 ☐ MHTR		6.3	X7F	22 μ	±10, ±20	10	150	2.5±0.20	R
JMK325 B7476∏MHTR		0.3	X7F	47 μ	±10, ±20	10	150	2.5±0.20	R

Temperature Characteristic B7 : X7R】 1.9mm thickness (N)											
Part number 2	Patad valtage [V]	Temperature	Capacitance	Capacitance	$ an\delta$	HALT	Th:-!*3 []	Soldering R:Reflow			
Fart number 2	Nated Voltage [V]	characteristics	[F]	tolerance [%]	[%]	Rated voltage x %	inickness [mm]	W:Wave			
	25	X7R	2.2 μ	±10, ±20	3.5	200	1.9±0.20	R			
	30	X7R	4.7 μ	±20	10	150	1.9±0.20	R			
	25	X7R	4.7 μ	±10, ±20	10	150	1.9±0.20	R			
	16	X7R	10 μ	±10, ±20	5	150	1.9±0.20	R			
	c B7 : X7R】 1.9mm thic Part number 2	Part number 2 Rated voltage [V]  35 25	Part number 2         Rated voltage [V]         Temperature characteristics           35         X7R           X7R         X7R           25         X7R	Part number 2   Rated voltage [V]   Temperature characteristics   Capacitance [F]	Part number 2   Rated voltage [V]   Temperature characteristics   Capacitance [F]   Capacitance tolerance [%]	Part number 2         Rated voltage [V]         Temperature characteristics         Capacitance [F]         Capacitance tolerance [%]         tan δ [%]           35         X7R         2.2 μ         ±10, ±20         3.5           X7R         4.7 μ         ±20         10           25         X7R         4.7 μ         ±10, ±20         10	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			

Temperature Characterist	ic B7 : X7R】 1.5mm thick	kness (H)								
Part number 1	Part number 2	Rated voltage [V]	Temperat characteris		Capacitance [F]	Capacitance tolerance [%]	tan δ [%]	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave
UMK325 B7105[]HHT		50		X7R	1 μ	±10, ±20	3.5	200	1.5±0.10	R

# Multilaver Ceramic Capacitors (Temperature compensating type) 105TYPE [Temperature Characteristic CG: CG/C0G] 0.5mm thickness(V)

Part number 1	Temperature Characteristi	c CG:CG/C0G】 0.5mr	n thickness(V)								
CG	David accombana 1	Dank	Data di caltana [V/]	Tempe	erature	Capacitance	Capacitance	0	HALT	*3 - 7	Soldering
UMK105 CG010CVHF         CG         COG         1 p         ±0.25pF         420         200         0.5±0.05           UMK105 CG018CVHF         CG         COG         COG         1.5 p         ±0.25pF         430         200         0.5±0.05           UMK105 CG030CVHF         CG         COG         COG         2 p         ±0.25pF         440         200         0.5±0.05           UMK105 CG030CVHF         CG         COG         COG         3 p         ±0.25pF         460         200         0.5±0.05           UMK105 CG030CVHF         CG         COG         COG         4 p         ±0.25pF         460         200         0.5±0.05           UMK105 CG030CVHF         CG         COG         COG         4 p         ±0.25pF         500         200         0.5±0.05           UMK105 CG030DVHF         CG         COG         COG         7 p         ±0.5pF         520         200         0.5±0.05           UMK105 CG030DVHF         CG         COG         7 p         ±0.5pF         540         200         0.5±0.05           UMK105 CG030DVHF         CG         COG         8 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG150JVHF	Part number i	Part number 2	Rated voitage [v]	charac	teristics	[F]	tolerance [%]	Q	Rated voltage x %	Thickness [mm]	R:Reflow W:Wave
UMK105 CG1R5CVHF         CG         COG         1.5 p         ±0.25pF         430         200         0.5±0.05           UMK105 CG020CVHF         CG         COG         2 p         ±0.25pF         440         200         0.5±0.05           UMK105 CG030CVHF         CG         COG         COG         3 p         ±0.25pF         460         200         0.5±0.05           UMK105 CG050CVHF         CG         COG         COG         4 p         ±0.25pF         480         200         0.5±0.05           UMK105 CG050CVHF         CG         COG         COG         5 p         ±0.25pF         500         200         0.5±0.05           UMK105 CG050CVHF         CG         COG         COG         5 p         ±0.25pF         500         200         0.5±0.05           UMK105 CG070DVHF         CG         COG         COG         7 p         ±0.5pF         540         200         0.5±0.05           UMK105 CG103DVHF         CG         COG         COG         8 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG150JVHF         CG         COG         COG         10 p         ±0.5pF         600         200         0.5±0.05           UMK	UMK105 CG0R5CVHF			CG	COG	0.5 p	±0.25pF	410	200	0.5±0.05	R
UMK105 CG020CVHF         CG         C0G         2 p         ±0.25pF         440         200         0.5±0.05           UMK105 CG030CVHF         CG         C0G         3 p         ±0.25pF         480         200         0.5±0.05           UMK105 CG050CVHF         CG         C0G         4 p         ±0.25pF         480         200         0.5±0.05           UMK105 CG050CVHF         CG         C0G         6 p         ±0.25pF         500         200         0.5±0.05           UMK105 CG060DVHF         CG         C0G         6 p         ±0.5pF         520         200         0.5±0.05           UMK105 CG080DVHF         CG         C0G         C0G         8 p         ±0.5pF         540         200         0.5±0.05           UMK105 CG080DVHF         CG         C0G         C0G         8 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG160DVHF         CG         C0G         C0G         9 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG160DVHF         CG         C0G         C0G         10 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG180JVHF         CG         C0G	UMK105 CG010CVHF			CG	COG	1 p	±0.25pF	420	200	$0.5 \pm 0.05$	R
UMK105 CG030CVHF         CG         COG         3 p         ±0.25pF         460         200         0.5±0.05           UMK105 CG050CVHF         CG         COG         4 p         ±0.25pF         480         200         0.5±0.05           UMK105 CG050CVHF         CG         COG         5 p         ±0.25pF         500         200         0.5±0.05           UMK105 CG060DVHF         CG         COG         6 p         ±0.5pF         520         200         0.5±0.05           UMK105 CG080DVHF         CG         COG         COG         7 p         ±0.5pF         540         200         0.5±0.05           UMK105 CG100DVHF         CG         COG         COG         9 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG100DVHF         CG         COG         OG         9 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG100DVHF         CG         COG         OG         10 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG150JVHF         CG         COG         COG         10 p         ±0.5pF         640         200         0.5±0.05           UMK105 CG180JVHF         CG         <	UMK105 CG1R5CVHF			CG	COG	1.5 p	±0.25pF	430	200	$0.5 \pm 0.05$	R
UMK105 CG040CVHF	UMK105 CG020CVHF			CG	COG	2 p	±0.25pF	440	200	$0.5 \pm 0.05$	R
UMK105 CG050CVHF	UMK105 CG030CVHF			CG	C0G	3 р	±0.25pF	460	200	0.5±0.05	R
UMK105 CG060DVHF   UMK105 CG070DVHF   UMK105 CG090DVHF   UMK105 CG090DVHF   UMK105 CG090DVHF   UMK105 CG090DVHF   CG CG CGG 8 p ±0.5pF 540 200 0.5±0.05	UMK105 CG040CVHF			CG	COG	4 p	±0.25pF	480	200	$0.5 \pm 0.05$	R
UMK105 CG070DVHF         CG         COG         7 p         ±0.5pF         540         200         0.5±0.05           UMK105 CG080DVHF         CG         COG         8 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG10DVHF         CG         COG         10 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG120JVHF         CG         COG         10 p         ±0.5pF         600         200         0.5±0.05           UMK105 CG150JVHF         CG         COG         12 p         ±5%         640         200         0.5±0.05           UMK105 CG180JVHF         CG         COG         18 p         ±5%         700         200         0.5±0.05           UMK105 CG220JVHF         CG         COG         18 p         ±5%         700         200         0.5±0.05           UMK105 CG330JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG380JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         33 p         ±5%         1000         200         0.5±0.0	UMK105 CG050CVHF			CG	COG	5 p	±0.25pF	500	200	$0.5 \pm 0.05$	R
UMK105 CG080DVHF         CG         COG         8 p         ±0.5pF         560         200         0.5±0.05           UMK105 CG090DVHF         CG         COG         9 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG100DVHF         CG         COG         10 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG120JVHF         CG         COG         12 p         ±5%         640         200         0.5±0.05           UMK105 CG180JVHF         CG         COG         12 p         ±5%         640         200         0.5±0.05           UMK105 CG220JVHF         CG         COG         12 p         ±5%         700         200         0.5±0.05           UMK105 CG370JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         COG         27 p         ±5%         940         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         39 p         ±5%         1000         200	UMK105 CG060DVHF			CG	COG	6 p	±0.5pF	520	200	$0.5 \pm 0.05$	R
UMK105 CG090DVHF         CG         COG         9 p         ±0.5pF         580         200         0.5±0.05           UMK105 CG100DVHF         CG         COG         10 p         ±0.5pF         600         200         0.5±0.05           UMK105 CG150JVHF         CG         COG         12 p         ±5%         640         200         0.5±0.05           UMK105 CG180JVHF         CG         COG         15 p         ±5%         700         200         0.5±0.05           UMK105 CG220JVHF         CG         COG         18 p         ±5%         760         200         0.5±0.05           UMK105 CG330JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         27 p         ±5%         940         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         68 p         ±5%         1000         200         0.5±0.05<	UMK105 CG070DVHF			CG	COG	7 p	±0.5pF	540	200	$0.5 \pm 0.05$	R
UMK105 CG100DVHF         CG         COG         10 p         ±0.5pF         600         200         0.5±0.05           UMK105 CG120JVHF         CG         COG         12 p         ±5%         640         200         0.5±0.05           UMK105 CG180JVHF         CG         COG         15 p         ±5%         700         200         0.5±0.05           UMK105 CG180JVHF         CG         COG         18 p         ±5%         760         200         0.5±0.05           UMK105 CG220JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG330JVHF         CG         COG         27 p         ±5%         940         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         33 p         ±5%         940         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG860JVHF         CG         COG         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG820JVHF         CG         COG         68 p         ±5%         1000         200         0.5±0.05 <td>UMK105 CG080DVHF</td> <td></td> <td></td> <td>CG</td> <td>COG</td> <td></td> <td>±0.5pF</td> <td></td> <td>200</td> <td><math>0.5 \pm 0.05</math></td> <td>R</td>	UMK105 CG080DVHF			CG	COG		±0.5pF		200	$0.5 \pm 0.05$	R
UMK105 CG120JVHF         CG         C0G         12 p         ±5%         640         200         0.5±0.05           UMK105 CG150JVHF         CG         C0G         15 p         ±5%         700         200         0.5±0.05           UMK105 CG180JVHF         CG         C0G         18 p         ±5%         760         200         0.5±0.05           UMK105 CG220JVHF         CG         C0G         22 p         ±5%         840         200         0.5±0.05           UMK105 CG390JVHF         CG         C0G         27 p         ±5%         940         200         0.5±0.05           UMK105 CG390JVHF         CG         C0G         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         C0G         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         C0G         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG860JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           CG         C0G         68 p         ±5%         1000         200         0.5±0.05           U	UMK105 CG090DVHF			CG	COG	9 p	±0.5pF	580	200	$0.5 \pm 0.05$	R
UMK105 CG150JVHF         CG         C0G         15 p         ±5%         700         200         0.5±0.05           UMK105 CG180JVHF         CG         C0G         18 p         ±5%         760         200         0.5±0.05           UMK105 CG220JVHF         CG         C0G         22 p         ±5%         760         200         0.5±0.05           UMK105 CG370JVHF         CG         C0G         22 p         ±5%         840         200         0.5±0.05           UMK105 CG330JVHF         CG         C0G         27 p         ±5%         940         200         0.5±0.05           UMK105 CG370JVHF         CG         C0G         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         C0G         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG680JVHF         CG         C0G         56 p         ±5%         1000         200         0.5±0.05           UMK105 CG820JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG101JVHF         CG         C0G         82 p         ±5%         1000         200         0.5±0.05 <td>UMK105 CG100DVHF</td> <td></td> <td></td> <td>CG</td> <td>COG</td> <td>10 p</td> <td>±0.5pF</td> <td>600</td> <td>200</td> <td><math>0.5 \pm 0.05</math></td> <td>R</td>	UMK105 CG100DVHF			CG	COG	10 p	±0.5pF	600	200	$0.5 \pm 0.05$	R
UMK105 CG180JVHF         CG         C0G         18 p         ±5%         760         200         0.5±0.05           UMK105 CG220JVHF         CG         C0G         22 p         ±5%         840         200         0.5±0.05           UMK105 CG330JVHF         CG         C0G         27 p         ±5%         940         200         0.5±0.05           UMK105 CG330JVHF         CG         C0G         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG390JVHF         CG         C0G         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         C0G         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG880JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG820JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG101JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG11JJVHF         CG         C0G         82 p         ±5%         1000         200         0.5±0.05 </td <td>UMK105 CG120JVHF</td> <td></td> <td></td> <td>CG</td> <td>COG</td> <td>12 p</td> <td>±5%</td> <td>640</td> <td>200</td> <td><math>0.5 \pm 0.05</math></td> <td>R</td>	UMK105 CG120JVHF			CG	COG	12 p	±5%	640	200	$0.5 \pm 0.05$	R
UMK105 CG220JVHF         CG         COG         22 p         ±5%         840         200         0.5±0.05           UMK105 CG270JVHF         CG         COG         27 p         ±5%         940         200         0.5±0.05           UMK105 CG330JVHF         CG         COG         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG390JVHF         CG         COG         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG360JVHF         CG         COG         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG880JVHF         CG         COG         68 p         ±5%         1000         200         0.5±0.05           CG         COG         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG320JVHF         CG         COG         82 p         ±5%         1000         200         0.5±0.05           UMK105 CG301JVHF         CG         COG         82 p         ±5%         1000         200         0.5±0.05           UMK105 CG301JVHF         CG         COG         100 p         ±5%         1000         200         0.5±0.05           <	UMK105 CG150JVHF			CG	COG	15 p	±5%	700	200	$0.5 \pm 0.05$	R
UMK105 CG270JVHF	UMK105 CG180JVHF			CG	COG	18 p	±5%	760	200	$0.5 \pm 0.05$	R
UMK105 CG330JVHF         CG         C0G         33 p         ±5%         1000         200         0.5±0.05           UMK105 CG390JVHF         CG         C0G         39 p         ±5%         1000         200         0.5±0.05           UMK105 CG560JVHF         CG         C0G         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG680JVHF         CG         C0G         56 p         ±5%         1000         200         0.5±0.05           UMK105 CG820JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG101JVHF         CG         C0G         82 p         ±5%         1000         200         0.5±0.05           UMK105 CG151JVHF         CG         C0G         100 p         ±5%         1000         200         0.5±0.05           UMK105 CG151JVHF         CG         C0G         150 p         ±5%         1000         200         0.5±0.05           UMK105 CG181JVHF         CG         C0G         150 p         ±5%         1000         200         0.5±0.05           UMK105 CG181JVHF         CG         C0G         150 p         ±5%         1000         200         0.5	UMK105 CG220JVHF			CG	COG	22 p	±5%	840	200	0.5±0.05	R
UMK105 CG390JVHF	UMK105 CG270JVHF			CG	COG	27 p	±5%	940	200	0.5±0.05	R
DMK105 CG470JVHF	UMK105 CG330JVHF			CG	COG	33 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG470JVHF         CG         C0G         47 p         ±5%         1000         200         0.5±0.05           UMK105 CG560JVHF         CG         C0G         56 p         ±5%         1000         200         0.5±0.05           UMK105 CG880JVHF         CG         C0G         68 p         ±5%         1000         200         0.5±0.05           UMK105 CG101JVHF         CG         C0G         82 p         ±5%         1000         200         0.5±0.05           UMK105 CG101JVHF         CG         C0G         100 p         ±5%         1000         200         0.5±0.05           UMK105 CG151JVHF         CG         C0G         150 p         ±5%         1000         200         0.5±0.05           UMK105 CG181JVHF         CG         C0G         150 p         ±5%         1000         200         0.5±0.05           UMK105 CG181JVHF         CG         C0G         180 p         ±5%         1000         200         0.5±0.05	UMK105 CG390JVHF		50	CG	COG	39 p	±5%	1000	200	0.5±0.05	R
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	UMK105 CG470JVHF		30	CG	COG	47 p	±5%	1000	200	0.5±0.05	R
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	UMK105 CG560JVHF			CG	COG	56 p	±5%	1000	200	$0.5 \pm 0.05$	R
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	UMK105 CG680JVHF			CG	COG	68 p	±5%	1000	200	$0.5 \pm 0.05$	R
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	UMK105 CG820JVHF			CG	COG	82 p	±5%	1000	200	$0.5 \pm 0.05$	R
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$											R
UMK105 CG181JVHF CG C0G 180 p ±5% 1000 200 0.5±0.05	UMK105 CG121JVHF			CG	COG	120 p	±5%	1000	200	$0.5 \pm 0.05$	R
	UMK105 CG151JVHF			CG	COG	150 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG221JVHF				CG		180 p		1000		$0.5 \pm 0.05$	R
24 254 E20 1000 E00 0.0±0.00	UMK105 CG221JVHF			CG	COG	220 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG271JVHF CG C0G 270 p ±5% 1000 200 0.5±0.05	UMK105 CG271JVHF			CG	COG	270 р	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG331JVHF CG CG C0G 330 p ±5% 1000 200 0.5±0.05	UMK105 CG331JVHF			CG	COG	330 р	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG361JVHF CG C0G 360 p ±5% 1000 200 0.5±0.05	UMK105 CG361JVHF			CG	COG	360 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG391JVHF CG C0G 390 p ±5% 1000 200 0.5±0.05	UMK105 CG391JVHF			CG	COG	390 р	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG431JVHF CG CG C0G 430 p ±5% 1000 200 0.5±0.05	UMK105 CG431JVHF	·		CG	C0G	430 p	±5%	1000	200	0.5±0.05	R
UMK105 CG471JVHF CG C0G 470 p ±5% 1000 200 0.5±0.05	UMK105 CG471JVHF	•		CG	COG	470 p	±5%	1000	200	0.5±0.05	R
UMK105 CG511JVHF CG CG C0G 510 p ±5% 1000 200 0.5±0.05	UMK105 CG511JVHF			CG	C0G	510 р	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG561JVHF CG C0G 560 p ±5% 1000 200 0.5±0.05	UMK105 CG561JVHF			CG	C0G	560 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG621JVHF CG C0G 620 p ±5% 1000 200 0.5±0.05	UMK105 CG621JVHF			CG	COG	620 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG681JVHF CG C0G 680 p ±5% 1000 200 0.5±0.05	UMK105 CG681JVHF			CG	COG	680 p	±5%	1000	200	0.5±0.05	R

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

Part number 1	Part number 2	Rated voltage [V]		erature teristics	Capacitance [F]	Capacitance tolerance [%]	Q	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave
UMK105 CG751JVHF			CG	COG	750 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG821JVHF		50	CG	COG	820 p	±5%	1000	200	$0.5 \pm 0.05$	R
UMK105 CG102JVHF			CG	COG	1000 p	±5%	1000	200	0.5±0.05	R

## Medium-High Voltage Multilayer Ceramic Capacitors ● 107TYPE

[Temperature Characteristic B7 : X7R] 0.8mm thickness(A)

Part number 1	Part number 2	Rated voltage [V]	Temperature	Capacitance	Capacitance	tan δ	HALT	Thickness*3 [mm]	Soldering R:Reflow
Part number 1	Part number 2	Nateu voitage [v]	characteristics	[F]	tolerance [%]	[%]	Rated voltage x %	inickness [mm]	W:Wave
HMK107 B7102[]AHT			X7R	1000 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7152□AHT			X7R	1500 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7222 AHT			X7R	2200 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7332∏AHT			X7R	3300 р	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7472∏AHT		100	X7R	4700 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7682∏AHT		100	X7R	6800 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7103∏AHT			X7R	10000 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7153∏AHT			X7R	0.015 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7223∏AHT			X7R	0.022 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7333∏AHT			X7R	0.033 μ	±10, ±20	3.5	200	0.8±0.10	R

### 212TYPE

[Temperature Characteristic B7 : X7R] 1.25mm thickness(G)

Part number 1	Part number 2	Rated voltage [V]	Temperature	Capacitance	Capacitance	tan δ	HALT	*3 5 7	Soldering R:Reflow
Part number 1	Part number 2		characteristics	teristics [F]	tolerance [%]	[%]	Rated voltage x %	Thickness*3 [mm]	W:Wave
HMK212 B7103[]GHT			X7R	10000 p	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7153∏GHT			X7R	0.015 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7223[]GHT			X7R	0.022 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7333∏GHT		100	X7R	0.033 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7473[]GHT		100	X7R	0.047 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7683[]GHT			X7R	0.068 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7104 GHT			X7R	0.1 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 B7224 GHT			X7R	0.22 μ	±10, ±20	3.5	200	1.25±0.10	R
QMK212 B7472 GHT			X7R	4700 p	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7682 GHT			X7R	6800 p	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7103[]GHT		250	X7R	10000 p	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7153 GHT			X7R	0.015 μ	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7223[]GHT			X7R	0.022 μ	±10, ±20	2.5	150	1.25±0.10	R

[Temperature Characteristic B7 : X7R] 0.85mm thickness(D)

Part number 1	Part number 2	Rated voltage [V]	Temperature characteristics	Capacitance [F]	Capacitance tolerance [%]	tan δ [%]	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave
QMK212 B7102[]DHT			X7F	1000 p	±10, ±20	2.5	150	$0.85 \pm 0.10$	R
QMK212 B7152[]DHT		250	X7F	1500 p	±10, ±20	2.5	150	$0.85 \pm 0.10$	R
QMK212 B7222[]DHT		230	X7F	2200 p	±10, ±20	2.5	150	$0.85 \pm 0.10$	R
QMK212 B7332[]DHT		1	X7F	3300 p	±10, ±20	2.5	150	$0.85 \pm 0.10$	R

### ●316TYPE

[Temperature Characteristic B7 : X7R] 1.6mm thickness(L)

Part number 1	Part number 2 Ra	Rated voltage [V]	Temperature characteristics	Capacitance	Capacitance	$ an\delta$	HALT	·· *3 r 7	Soldering
Part number 1	Part number 2			[F]	tolerance [%]	[%]	Rated voltage x %	Thickness*3 [mm]	R:Reflow W:Wave
HMK316 B7473 LHT			X7R	0.047 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7104□LHT			X7R	0.1 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7154□LHT			X7R	0.15 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7224□LHT		100	X7R	0.22 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7334□LHT			X7R	0.33 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7474□LHT			X7R	0.47 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7105□LHT			X7R	1 μ	±10, ±20	3.5	200	1.6±0.20	R
QMK316 B7333 LHT			X7R	0.033 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7473[]LHT		250	X7R	0.047 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7683[]LHT		250	X7R	0.068 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7104[]LHT			X7R	0.1 μ	±10, ±20	2.5	150	1.6±0.20	R
SMK316 B7153 LHT		630	X7R	0.015 μ	±10, ±20	2.5	120	1.6±0.20	R
SMK316 B7223[]LHT		030	X7R	0.022 μ	±10, ±20	2.5	120	1.6±0.20	R

[Temperature Characteristic B7 : X7R] 1.15mm thickness(F)

Part number 1 F	Part number 2	Rated voltage [V]	Temperature	Capacitance	Capacitance	tan δ	HALT	*3 5 7	Soldering R:Reflow
	Part number 2	Rated Voltage [V]	characteristics	[F]	tolerance [%]	[%]	Rated voltage x %	Thickness*3 [mm]	W:Wave
SMK316 B7102[]FHT			X7R	1000 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7152[]FHT			X7R	1500 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7222[]FHT			X7R	2200 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7332∏FHT		630	X7R	3300 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7472[]FHT			X7R	4700 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7682[]FHT			X7R	6800 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7103[]FHT			X7R	10000 p	±10, ±20	2.5	120	1.15±0.10	R

### ●325TYPE

erature Characteristic B7 : X7R 2 5mm thickness (M)

Tremperature onaractorist	Tomporature on a recent of the											
Part number 1	Part number 2	Rated voltage [V]	Tempe charact		Capacitance [F]	Capacitance tolerance [%]	tan δ [%]	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave		
HMK325 B7225 MHT		100		X7R	2.2 μ	±10, ±20	3.5	200	2.5±0.20	R		

[Temperature Characteristic B7 : X7R] 1.9mm thickness(N)

Part number 1	Part number 2	Rated voltage [V]	erature ceristics	Capacitance [F]	Capacitance tolerance [%]	tan δ [%]	HALT Rated voltage x %	Thickness*3 [mm]	Soldering R:Reflow W:Wave
HMK325 B7224 NHT		100	X7R	0.22 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7474 NHT		100	X7R	0.47 μ	±10, ±20	3.5	200	1.9±0.20	R

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## **Multilayer Ceramic Capacitors**

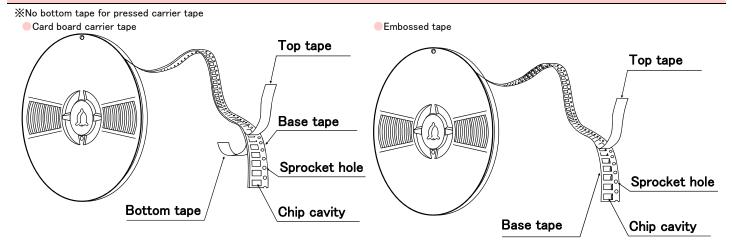
### ■PACKAGING

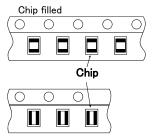
### 1)Minimum Quantity

Taped package				
Type(EIA)	Thick	ness	Standard o	uantity [pcs]
Туре(ЕІА)	mm	code	Paper tape	Embossed tape
☐MK042(01005)	0.2	C, D		40000
□VS042(01005)	0.2	С	7 -	40000
☐MK063(0201)	0.3	P, T	15000	
□WK105(0204) ※	0.3	Р	10000	
	0.2	С	20000	
☐MK105(0402)	0.3	Р	15000	_
	0.5	٧	10000	
□VK105(0402) ※	0.5	W	10000	
□MK107(0603)	0.45	K	4000	1
□WK107(0306) ※	0.5	V	_	4000
□MR107(0603)	0.8	Α		
□MK212(0805)	0.45	K	4000	_
□WK212(0508) ※	0.85	D		
□MR212(0805)	125	G	_	3000
	0.85	D	4000	_
□MK316(1206)	1.15	F		2000
□MR316(1206)	125	G	_	3000
	1.6	L	_	2000
	0.85	D		
	1.15	F		
□MK325(1210)	1.9	N	7 -	2000
□MR325(1210)	2.0max.	Υ		
	2.5	М		500(T), 1000(P)
□MK432(1812)	2.5	М	_	500

Note: X LW Reverse type.

### ②Taping material



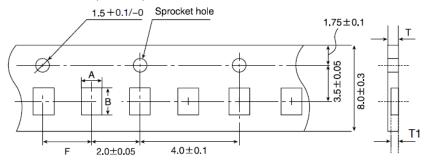


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### 3 Representative taping dimensions

### Paper Tape (8mm wide)

### ● Pressed carrier tape (2mm pitch)

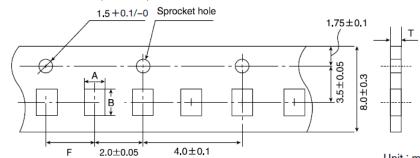


			Onit : mm			
Type(EIA)	Chip	Cavity	Insertion Pitch	Tape Thickness		
Type(EIA)	Α	В	F	Т	T1	
☐MK063(0201)	0.37	0.67		0.45max.	0.42max.	
□WK105(0204) ※			2.0±0.05	0.45max.	0.42max.	
☐MK105(0402) (*1 C)	0.65	1.15	2.0±0.03	0.4max.	0.3max.	
□MK105(0402) (*1 P)				0.45max.	0.42max.	

Note \*1 Thickness, C:0.2mm ,P:0.3mm. \* LW Reverse type.

Unit:mm

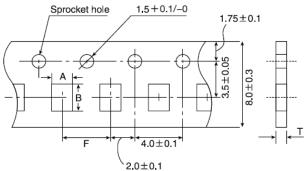
### ●Punched carrier tape (2mm pitch)



			Unit : mm		
Type(EIA)	Chip (	Cavity	Insertion Pitch	Tape Thickness	
Type(EIA)	Α	В	F	Т	
□MK105 (0402) □VK105 (0402)	0.65	1.15	2.0±0.05	0.8max.	

Unit:mm

### ●Punched carrier tape (4mm pitch)



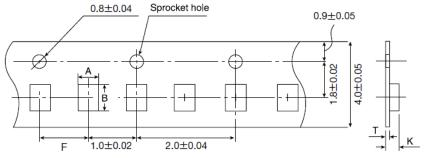
	2.0 ± 0.1	Unit	: mm		
Type(EIA)	Chip	Cavity	Insertion Pitch	Tape Thickness	
Type(EIA)	A B		F	Т	
☐MK107(0603)					
□WK107(0306) ※	1.0	1.8		1.1max.	
☐MR107(0603)			40101		
☐MK212(0805)	1.05	0.4	4.0±0.1		
□WK212(0508) ※	1.65	2.4		1.1max.	
☐MK316(1206)	2.0	3.6			
				•	

Note: Taping size might be different depending on the size of the product. 💥 LW Reverse type.

Unit:mm

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### Embossed tape (4mm wide)

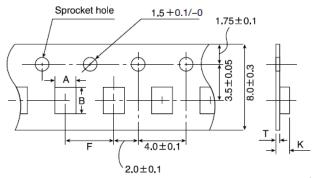


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Τ /ΓΙΔ )	Chip (	Cavity	Insertion Pitch	Tape Thickness		
Type(EIA)	Α	В	F	K	Т	
☐MK042(01005)	0.00	0.40	10+000	0.5	0.05	
□VS042(01005)	0.23	0.43	1.0±0.02	0.5max.	0.25max.	

 $\mathsf{Unit}\!:\!\mathsf{mm}$ 

### Embossed tape (8mm wide)

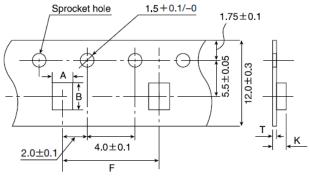


Unit: mm

Type(EIA)	Chip (	Cavity	Insertion Pitch	Tape Thickness		
Type(EIA)	Α	В	F	K	Т	
□WK107(0306) ※	1.0	1.8		1.3max.	0.25±0.1	
□MK212(0805) □MR212(0805)	1.65	2.4			0.6max.	
□MK316(1206) □MR316(1206)	2.0	3.6	4.0±0.1	3.4max.		
□MK325(1210) □MR325(1210)	2.8	3.6				

Note: \* LW Reverse type. Unit:mm

### Embossed tape (12mm wide)



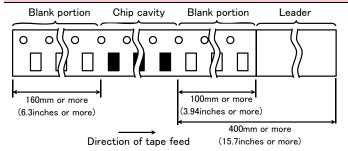
mm

Type(EIA)	Chip (	Cavity	Insertion Pitch	Tape Thickness		
	Α	В	F	K	Т	
□MK432(1812)	3.7	4.9	8.0±0.1	4.0max.	0.6max.	

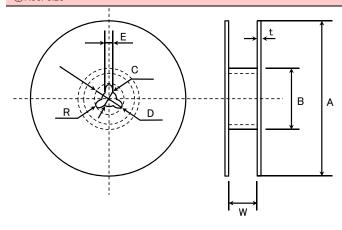
Unit:mm

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### 4 Trailer and Leader



### **5**Reel size



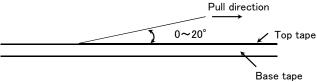
Α	В	С	D	E	R
$\phi$ 178 ± 2.0	$\phi$ 50min.	$\phi$ 13.0 $\pm$ 0.2	$\phi$ 21.0 $\pm$ 0.8	2.0±0.5	1.0

	Т	W
4mm wide tape	1.5max.	5±1.0
8mm wide tape	2.5max.	10±1.5
12mm wide tape	2.5max.	14±1.5

Unit:mm

### $\textbf{\^{6}} \textbf{Top Tape Strength}$

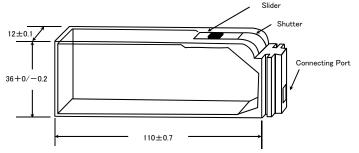
The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.

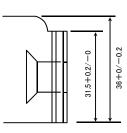


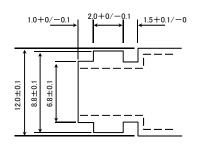
### **7**Bulk Cassette

The exchange of individual specification is necessary.

Please contact Taiyo Yuden sales channels.







Unit:mm

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## Multilayer Ceramic Capacitors

### ■RELIABILITY DATA

Test

Methods and

Remarks

Applied voltage

Charge/discharge current

1.Operating Te	mperature Range		_				
	Temperature	Standard	EE +- 1	10E°C			
Compensating(Class1)		High Frequency Type	−55 to +				
				Specification	Temperature	Range	
			В	В	-25 to +	85°C	
		BJ	X5R	-55 to +	85°C		
Specified			B7	X7R	-55 to +	125°C	
/alue	High Permittivity (Class2	)	C6	X6S	-55 to +	105°C	
	High Fermittivity (Glassz	,	C7	X7S	-55 to +	125°C	
			LD(※)	X5R	-55 to +	85°C	
			ll F	F	-25 to +		
				Y5V	-30 to +	85°C	
			Note: 🔆	LD Low distortion	high value multilayer	ceramic capac	
Storage Cor	nditions						
·	Temperature	Standard		10500			
	Compensating(Class1)	High Frequency Type	−55 to +	-125°C			
		0 1 3 31		Specification	Temperature	Dange	
				B	-25 to +		
Specified Value			BJ	X5R	-55 to +		
			B7	X7R	-55 to +		
		C6	X6S	-55 to +			
	High Permittivity (Class2	C7	X7S	-55 to +			
		LD(※)	X5R	-55 to +			
			F	-25 to +			
			F	Y5V	-30 to +		
			Note: 🔆	LD Low distortion	high value multilayer	ceramic capac	
	1						
Rated Volta	ge						
	Temperature	Standard	50VDC, 25	VDC, 16VDC			
pecified	Compensating(Class1)	High Frequency Type	50VDC, 25VDC, 16VDC				
alue					20 10//00 20//55	1) /DO 651 /D 5	
	High Permittivity (Class2	)	50VDC, 35VDC, 25VDC, 16VDC, 10VDC, 6.3VDC, 4VDC, 2.5VDC				
. Withstanding	y Voltage (Between termina	ls)					
	Temperature	Standard					
Specified	Compensating(Class1)	High Frequency Type	No breakdo	own or damage			
/alue	High Permittivity (Class2		1	-			
	g (5.400E		200 1		Class 2		
Test			ass 1 oltage × 3		Class 2 I voltage × 2.5		
lethods and	Duration			1 to 5 sec.	i voitage ^ Z.3		
lemarks	Charge/discharge curre	nt		50mA max.			
	Onarge/ discharge curren	10		OUTIN THAX.			
Insulation R	esistance						
	Temperature	Standard	10000 110				
Specified	Compensating(Class1)	High Frequency Type	10000 MΩ	min.			
Value		5 ,, 1,750	C<0.047.4	μ F : 10000 M Ω mi	n		
	High Permittivity (Class2	) Note 1			11.		
			$C > 0.047 \mu\text{F} : 500\text{M}\Omega \cdot \mu\text{F}$				

: Rated voltage

 $:60\pm5$  sec.

: 50mA max.

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6. Capacitance (Tolerance)							
	Temperature Compensating(Class1)	Standard		0.2pF≦C≦5pF 0.2pF≦C≦10pF C>10pF	: ±0.25pF : ±0.5pF : ±5% or ±10%		
Specified Value	Compensating (Class)	High Frequency Type	СН	0.2pF≦C≦2pF C>2pF	: ±0.1pF : ±5%		
	High Permittivity (Class2)			BJ, B7, C6, C7, LD( $\dot{x}$ ): $\pm 10\%$ or $\pm 20\%$ , F: $+80/-20\%$ Note: $\dot{x}$ LD Low distortion high value multilayer ceramic capacitor			
			Class 1		Class 2		
Test		Standard	d	High Frequency Type	C≦10 <i>μ</i> F	C>10 μ F	
Nethods and	Preconditioning		None		Thermal treatment (at 150°C for 1hr) Note 2		
Remarks	Measuring frequency	Measuring frequency		±10%	1kHz±10%	120±10Hz	
Remarks	Measuring voltage Note		0.5 to 5Vrms		1±0.2Vrms	0.5±0.1Vrms	
	Bias application		None				

7. Q or Dissipation Factor							
Specified Value	Temperature Compensating(Class1)		tandard $C < 30pF : Q \ge 400 + 20C$ $C \ge 30pF : Q \ge 1000$ (C:Nominal capacitance)				
	Compensating (Class)	High Frequency Type Refer to detailed specificat		to detailed specification	ion		
	High Permittivity (Class2) Note 1			BJ, B7, C6, C7:2.5% max., F:7% max.			
			Class 1		Class 2		
			Standard		High Frequency Type	C≦10 <i>µ</i> F	C>10 $\mu$ F
	Preconditioning		None		Thermal treatment (at 150°C for 1hr) Note 2		
Test	Measuring frequency		1MHz±10%		1GHz	1kHz±10%	120±10Hz
Methods and	Measuring voltage Note 1		0.5 to 5Vrms				
Remarks	Bias application		None				
	High Frequency Type						
	Measuring equipment	: HP	4291A				
	Measuring jig	: HP	16192A				

8. Temperature Characteristic (Without voltage application)									
			Temperature Characteristic [ppm/°C]				Tolerance [ppm/°C]		
			C□:	0	CG,CH, CJ, (	CK		G: ±30	
		Standard						H: ±60	
Specified Value	Temperature	Standard	U□ :	<del></del>	UJ, UK			J: ±120	
	Compensating(Class1)							K: ±250	
			SL :	+350 to −100	00				
		Uliab Farance Tona	Tem	perature Charac	cteristic [ppm/°	m/°C] Tole		rance [ppm/°C]	
		High Frequency Type	C□:	0	CH		H: ±60		
			Specification	Capacitance change	Refer tempe		Temperature Range		
			BJ	В	±10%	20	°C	−25 to +85°C	
				X5R	±15%	25°	°C	−55 to +85°C	
			B7	X7R	±15%	25°	°C	−55 to +125°C	
	High Permittivity (Class2)		C6	X6S	±22%	25	°C	-55 to +105°C	
			C7	X7S	±22%	25	°C	-55 to +125°C	
			LD(※)	X5R	±15%	25	°C	-55 to +85°C	
			F	F	+30/-80%	20	°C	-25 to +85°C	
				Y5V	+22/-82%	25	°C	-30 to +85°C	
			Note:	LD Low disto	ortion high value	multilayeı	r cerami	c capacitor	

Class 1

Capacitance at  $20^{\circ}$ C and  $85^{\circ}$ C shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.

$$\frac{(C_{85}-C_{20})}{C_{20}\times\Delta T} \times 10^{6} (ppm/^{\circ}C) \qquad \Delta T = 65$$

Test Methods and Remarks

Class 2

Capacitance at each step shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.

Step	B, F	X5R, X7R, X6S, X7S, Y5V		
1	Minimum operating temperature			
2	20°C	25°C		
3	Maximum operating temperature			

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× 100 (%)

: Capacitance in Step 1 or Step 3

C2 : Capacitance in Step 2

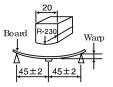
9. Deflection				
Specified Value	Temperature	Standard Appearance Capacitance change		: No abnormality : Within $\pm 5\%$ or $\pm 0.5$ pF, whichever is larger.
	Compensating(Class1)	High Frequency Type	Appearance Capacitance change	: No abnormality : Within $\pm 0.5$ pF
	High Permittivity (Class2)	)	Appearance Capacitance change	: No abnormality : Within $\pm 12.5\%$ (BJ, B7, C6, C7,LD( $\%$ )) Within $\pm 30\%$ (F)

Note: XLD Low distortion high value multilayer ceramic capacitor

Test Methods and Remarks

	Multilayer Ceramic Capacitors				
	042, 063, *105 Type	The other types			
Board	Glass epoxy-resin substrate				
Thickness	0.8mm	1.6mm			
Warp	1mm				
Duration	10 sec.				





Capacitance measurement shall be conducted with the board bent

10. Body Stren	10. Body Strength					
Specified Value	Temperature	Standard	-			
	Compensating(Class1)	High Frequency Type	No mechanical damage.			
Value	High Permittivity (Class2	)	-			
Test Methods and Remarks	High Frequency Type Applied force : 5N Duration : 10 sec.  Pres  ← A → Pres		R0.5 Pressing Jig Chip  A			

11. Adhesive S	11. Adhesive Strength of Terminal Electrodes					
Specified Value	Temperature	Standard				
	Compensating(Class	1) High Frequency Ty	ype No terminal separat	No terminal separation or its indication.		
- Value	High Permittivity (C	lass2)				
	Multilayer Ceramic		amic Capacitors	Hooked jig		
Test		042, 063 Type	105 Type or more			
Methods and	Applied force	2N	5N	R=05           Board		
Remarks	Duration	30±	:5 sec.	]		
				☐ ☐ ☐ Chip ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐		

12. Solderability	12. Solderability					
	Temperature	Standard				
Specified Value	Compensating(Class1)	High Frequency Type	At least 95%	At least 95% of terminal electrode is covered by new solder.		
value	High Permittivity (Class2)	)				
<b>-</b>	Eutecti		Eutectic solder Lead-free solder			
Test Methods and	Solder type	H60A or H	63A	Sn-3.0Ag-0.5Cu		
Remarks	Solder temperature	230±5°	С	245±3℃		
	Duration		4±1	sec.		

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8. Resistance	to Soldering		
Specified Value	Temperature	Standard	Appearance : No abnormality  Capacitance change : Within ±2.5% or ±0.25pF, whichever is larger.  Q : Initial value  Insulation resistance : Initial value  Withstanding voltage (between terminals) : No abnormality
	Compensating(Class1)	High Frequency Type	Appearance : No abnormality Capacitance change : Within ±2.5% Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
	High Permittivity(Class2) Note 1		Appearance : No abnormality Capacitance change : Within ±7.5%(BJ, B7, C6, C7, LD(※)) Within ±20%(F) Dissipation factor : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals): No abnormality Note: ※LD Low distortion high value multilayer ceramic capacitor
			Class 1
		042, 063 Type	105 Type
	Preconditioning		None
	Preheating	150°C, 1 to 2 min.	80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5 min.
	Solder temp.		270±5°C
	Duration		3±0.5 sec.
Γest ∕lethods and	Recovery	6 to 24 hrs	rs (Standard condition) Note 5
Remarks			Class 2
		042,063 Type	105, 107, 212 Type 316, 325 Type
	Preconditioning		Thermal treatment (at 150°C for 1 hr) Note 2
	Preheating	150°C, 1 to 2 min.	80 to 100°C, 2 to 5 min. 80 to 100°C, 5 to 10 min. 150 to 200°C, 2 to 5 min. 150 to 200°C, 5 to 10 min.
	Solder temp.		270±5℃
	Duration		3±0.5 sec.
	Recovery		24±2 hrs (Standard condition) Note 5

14. Temperatur	re Cycle (Thermal Shock)				
Specified Value	Temperature	Standard	Capacitance change : V Q : In Insulation resistance : In	No abnormality Nithin ±2.5% or ±0.25 nitial value nitial value petween terminals): N	pF, whichever is larger. o abnormality
	Compensating(Class1)	High Frequency Type	Capacitance change : V Q : In Insulation resistance : In	No abnormality Nithin ±0.25pF nitial value nitial value petween terminals): N	o abnormality
	High Permittivity(Class2	) Note 1	Capacitance change : W  Dissipation factor : Ir  Insulation resistance : Ir	No abnormality Vithin ±7.5% (BJ, B7, Within ±20% (F) nitial value nitial value vetween terminals) : No high value multilayer c	o abnormality
		(	Class 1		Class 2
	Preconditioning		None Thermal treatment (at 150°C for 1 Note 2		· · · · · · · · · · · · · · · · · · ·
Test Methods and Remarks	1 cycle	Step 1 2 3 4	Temperatur Minimum operating Normal temp Maximum operating Normal temp	g temperature perature g temperature perature	Time (min.) 30±3 2 to 3 30±3 2 to 3
	Number of cycles			times	
	Recovery	6 to 24 hrs(Star	ndard condition)Note 5	24±2 hrs (S	Standard condition)Note 5

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15. Humidity (Steady State)					
	Temperature Compensating(Class1	Standard	Appearance Capacitance change Q Insulation resistance	: No abnormality : Within $\pm 5\%$ or $\pm 0.5$ pF, whichever is larger. : C $< 10$ pF : Q $\ge 200 + 10$ C $10 \le C < 30$ pF : Q $\ge 275 + 2.5$ C C $\ge 30$ pF:Q $\ge 350$ (C:Nominal capacitance) : $1000 \text{ M}\Omega$ min.	
Specified Value		High Frequency Type	Appearance Capacitance change Insulation resistance	: No abnormality : Within $\pm 0.5 pF$ , : $1000~M~\Omega$ min.	
	High Permittivity (Class2) Note 1		Appearance Capacitance change Dissipation factor Insulation resistance Note: ※LD Low distort	: No abnormality : Within ±12.5% (BJ, B7, C6, C7, LD(※)) Within ±30% (F) : 5.0% max.(BJ, B7, C6, C7, LD(※)) 11.0% max.(F) : 50 M Ω μ F or 1000 M Ω whichever is smaller. tion high value multilayer ceramic capacitor	
			ass 1	Class 2	
_		Standard	High Frequency Typ		
Test	Preconditioning		one	Thermal treatment (at 150°C for 1 hr) Note 2	
Methods and Remarks	Temperature	40±2°C	60±2°C	40±2°C	
Remarks	Humidity		95%RH	90 to 95%RH	
	Duration Recovery		4/-0 hrs ard condition)Note 5	500+24/-0 hrs 24±2 hrs (Standard condition) Note 5	

16. Humidity Lo	pading			
Specified Value	Temperature	Standard	Appearance Capacitance change Q Insulation resistance	: No abnormality : Within $\pm 7.5\%$ or $\pm 0.75$ pF, whichever is larger. : $C < 30$ pF: $Q \ge 100 + 10$ C/3 $C \ge 30$ pF: $Q \ge 200$ (C: Nominal capacitance) : $500$ M $\Omega$ min.
	Compensating(Class1)	High Frequency Type	Appearance Capacitance change Insulation resistance	: No abnormality : C≦2pF: Within ±0.4 pF C>2pF: Within ±0.75 pF (C: Nominal capacitance) : 500 MΩ min.
	High Permittivity(Class2) Note 1		Appearance Capacitance change Dissipation factor Insulation resistance Note: ※LD Low distort	: No abnormality : Within $\pm$ 12.5% (BJ, B7, C6, C7, LD( $\stackrel{.}{\otimes}$ )) Within $\pm$ 30% (F) : 5.0% max. (BJ, B7, C6, C7, LD( $\stackrel{.}{\otimes}$ )) 11.0% max. (F) : 25 M $\Omega$ $\mu$ F or 500 M $\Omega$ , whichever is smaller. ion high value multilayer ceramic capacitor
		(	Class 1	Class 2
		Standard	High Frequency Typ	e All items
	Preconditioning		None	Voltage treatment (Rated voltage are applied for 1 hour at 40°C) Note 3
Test	Temperature	40±2°C	60±2°C	40±2°C
Methods and	Humidity	90 1	to 95%RH	90 to 95%RH
Remarks	Duration	500+	24/-0 hrs	500+24/-0 hrs
	Applied voltage	Rate	ed voltage	Rated voltage
	Charge/discharge current	50	mA max.	50mA max.
	Recovery	6 to 24 hrs (Stan	dard condition)Note 5	24±2 hrs(Standard condition) Note 5

<sup>►</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

17. High Temp	erature Loading					
Specified Value	Temperature Compensating(Class1)	Standard	Appearance Capacitance change Q Insulation resistance	: C<10pF: Q≧200+10C 10≦C<30pF:Q≧275+2.5C C≧30pF: Q≧350(C:Nominal capacitance)		
		High Frequency Type	Appearance : No abnormality Capacitance change : Within $\pm 3\%$ or $\pm 0.3$ pF, whichever is larger. Insulation resistance : $1000 \text{ M}\Omega$ min.		is larger.	
	High Permittivity(Class2	) Note 1	Appearance Capacitance change Dissipation factor Insulation resistance Note: %LD Low dist	Within ±30%: 5.0% max.(BJ, 11.0% max.(F)	6 (BJ, B7, C6, C7, L (F) B7, C6, C7, LD(※))	r is smaller.
			ss 1		Class 2	
	Preconditioning	Standard High Frequency Type  None		BJ, LD(%), F C6 B7, C7  Voltage treatment (Twice the rated voltage shall be applied for 1 hour at 85°C. 105°C or 125°C) Note 3, 4		
Test	Temperature	Maximum operat	ing temperature	Maxi	mum operating tem	perature
Methods and	Duration	1000+4	8/-0 hrs		1000+48/-0 hr	's
Remarks	Applied voltage	Rated vo	oltage × 2	F	Rated voltage × 2 N	ote 4
Nemarks	Charge/discharge current	50m <i>A</i>	A max.		50mA max.	
				24±2 hrs(Standard condition)Note 5		

Note: XLD Low distortion high value multilayer ceramic capacitor

- Note 1 The figures indicate typical specifications. Please refer to individual specifications in detail.
- Note 2 Thermal treatment : Initial value shall be measured after test sample is heat-treated at  $150 \pm 0/-10^{\circ}$ C for an hour and kept at room temperature for  $24 \pm 2$ hours.
- Note 3 Voltage treatment: Initial value shall be measured after test sample is voltage-treated for an hour at both the temperature and voltage specified in the test conditions, and kept at room temperature for 24±2hours.
- Note 4 150% of rated voltage is applicable to some items. Please refer to their specifications for further information.
- Note 5 Standard condition: Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.
  - Temperature:  $20\pm2^{\circ}$ C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa Unless otherwise specified, all the tests are conducted under the "standard condition".

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## Precautions on the use of Multilayer Ceramic Capacitors

### **■**PRECAUTIONS

#### 1. Circuit Design

- ◆Verification of operating environment, electrical rating and performance
  - A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications.

Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

#### Precautions

- ◆Operating Voltage (Verification of Rated voltage)
  - 1. The operating voltage for capacitors must always be their rated voltage or less.
    - If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less.
    - For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.
  - 2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency AC voltage or a pulse voltage having rapid rise time is used in a circuit.

### 2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
  - 1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance. Therefore, the following items must be carefully considered in the design of land patterns:
    - (1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.
    - (2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.
- ◆Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

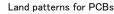
◆Pattern configurations (Design of Land-patterns)

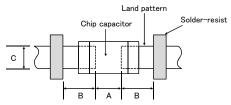
The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.

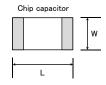
- (1) Recommended land dimensions for typical chip capacitors
  - Multilayer Ceramic Capacitors : Recommended land dimensions (unit: mm)

Wave-soldering

Trave coldering							
Туре		107	212	316	325		
Size L W	L	1.6	2.0	3.2	3.2		
	W	0.8	1.25	1.6	2.5		
À		0.8 to 1.0	1.0 to 1.4	1.8 to 2.5	1.8 to 2.5		
В		0.5 to 0.8	0.8 to 1.5	0.8 to 1.7	0.8 to 1.7		
С		0.6 to 0.8	0.9 to 1.2	1.2 to 1.6	1.8 to 2.5		







## Technical considerations

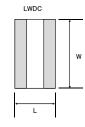
### Reflow-soldering

1101	Notion Soldering								
Ту	ре	042	063	105	107	212	316	325	432
Size	L	0.4	0.6	1.0	1.6	2.0	3.2	3.2	4.5
Size	W	0.2	0.3	0.5	0.8	1.25	1.6	2.5	3.2
-	4	0.15 to 0.25	0.20 to 0.30	0.45 to 0.55	0.8 to 1.0	0.8 to 1.2	1.8 to 2.5	1.8 to 2.5	2.5 to 3.5
E	3	0.15 to 0.20	0.20 to 0.30	0.40 to 0.50	0.6 to 0.8	0.8 to 1.2	1.0 to 1.5	1.0 to 1.5	1.5 to 1.8
(	)	0.15 to 0.30	0.25 to 0.40	0.45 to 0.55	0.6 to 0.8	0.9 to 1.6	1.2 to 2.0	1.8 to 3.2	2.3 to 3.5

 ${\bf Note:} Recommended \ land \ size \ might \ be \ different \ according \ to \ the \ allowance \ of \ the \ product.$ 

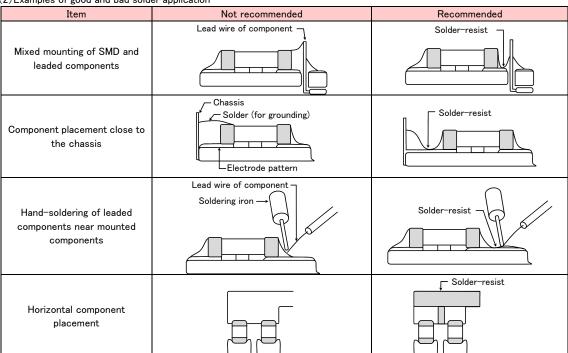
## ●LWDC: Recommended land dimensions for reflow-soldering (unit: mm)

( ,						
Туре		105	107	212		
C: L		0.52	0.8	1.25		
Size	W	1.0	1.6	2.0		
À		0.18 to 0.22	0.25 to 0.3	0.5 to 0.7		
В		0.2 to 0.25	0.3 to 0.4	0.4 to 0.5		
С		0.9 to 1.1	1.5 to 1.7	1.9 to 2.1		



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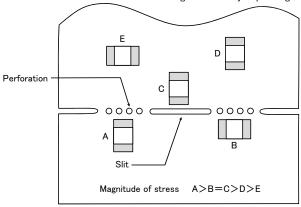
(2) Examples of good and bad solder application



- ◆Pattern configurations (Capacitor layout on PCBs)
  - 1-1. The following is examples of good and bad capacitor layouts; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.

Items	Not recommended	Recommended
Deflection of board		Place the product at a right angle to the direction of the anticipated mechanical stress.

1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

### 3. Mounting

- ◆Adjustment of mounting machine
  - 1. When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
  - 2. Maintenance and inspection of mounting machines shall be conducted periodically.

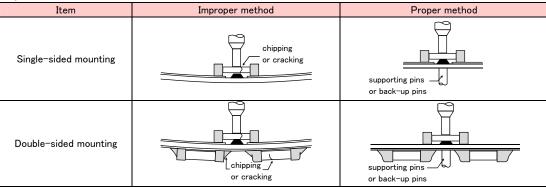
### Precautions Selection of Adhesives

1. When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked: size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.

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#### ◆Adjustment of mounting machine

- 1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
  - (1) The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
  - (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
  - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:



## Technical considerations

2. As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors.

To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted periodically.

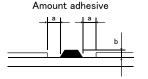
### ◆Selection of Adhesives

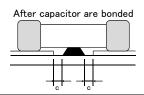
Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
  - a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process.
  - b. The adhesive shall have sufficient strength at high temperatures.
  - c. The adhesive shall have good coating and thickness consistency.
  - d. The adhesive shall be used during its prescribed shelf life.
  - e. The adhesive shall harden rapidly.
  - f. The adhesive shall have corrosion resistance.
  - g. The adhesive shall have excellent insulation characteristics.
  - h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- (2) The recommended amount of adhesives is as follows;

[Recommended condition]

a 0.3mm min b 100 to 120 $\mu$ m	
b 100 to 120 $\mu$ m	
c Adhesives shall not contact land	





### 4. Soldering

Precautions

### ◆Selection of Flux

Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;

- (1) Flux used shall be less than or equal to 0.1 wt%( in Cl equivalent) of halogenated content. Flux having a strong acidity content shall not be applied.
- (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
- (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

### **♦**Soldering

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions.

Sn-Zn solder paste can adversely affect MLCC reliability.

Please contact us prior to usage of Sn-Zn solder.

### ◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to corrosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.
- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

Technical

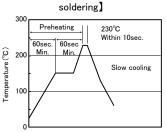
considerations

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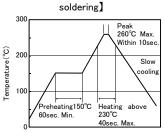
### **♦**Soldering

- · Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal shock
- Preheating: Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 100 to 130°C.
- Cooling: The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.
   [Reflow soldering]

[Recommended conditions for eutectic

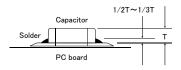


[Recommended condition for Pb-free



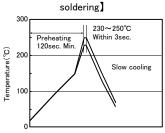
#### Caution

- $\bigcirc$  The ideal condition is to have solder mass(fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- ②Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible.

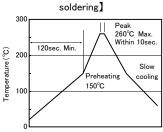


### [Wave soldering]

[Recommended conditions for eutectic



### [Recommended condition for Pb-free

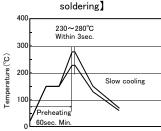


#### Caution

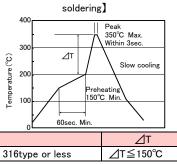
①Wave soldering must not be applied to capacitors designated as for reflow soldering only.

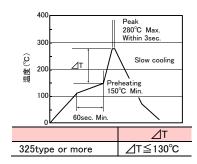
### [Hand soldering]

[Recommended conditions for eutectic



### [Recommended condition for Pb-free





### Caution

- ①Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- 2The soldering iron shall not directly touch capacitors.

### 5. Cleaning

Precautions

Technical

considerations

### 4 WI DOD

- 1. When PCBs are cleaned after capacitors mounting, please select the appropriate cleaning solution in accordance with the intended use of the cleaning. (e.g. to remove soldering flux or other materials from the production process.)
- 2. Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics.

# 1. The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance).

2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the cracking of capacitors or the soldered portion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall be carefully checked;

Ultrasonic output: 20 W/l or less
Ultrasonic frequency: 40 kHz or less
Ultrasonic washing period: 5 min. or less

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#### 6. Resin coating and mold 1. With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the capacitor's performance. Precautions 2. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat may lead to damage or destruction of capacitors. The use of such resins, molding materials etc. is not recommended.

### 7. Handling ◆Splitting of PCB 1. When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board. 2. Board separation shall not be done manually, but by using the appropriate devices. Precautions ◆Mechanical considerations Be careful not to subject capacitors to excessive mechanical shocks. (1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used. (2) Please be careful that the mounted components do not come in contact with or bump against other boards or

8. Storage condi	tions
Precautions	<ul> <li>◆Storage</li> <li>1. To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.</li> <li>•Recommended conditions         <ul> <li>Ambient temperature: Below 30°C</li> <li>Humidity: Below 70% RH</li> <li>The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery.</li> <li>•Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air.</li> <li>The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, so care shall be taken to design circuits: Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1hour.</li> </ul> </li> </ul>
Technical considerations	If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/packaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the capacitors.

Please check the guide regarding precautions for deflection test, soldering by spot heat, and so on.

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